## 10/8/4/212

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S5	130	((die or chip) with silicon) and (thermal adj interface adj material)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/07 15:29
S6	2411	257/706	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/07 16:08
S7	1933	257/707	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/07 16:11
S8	839	438/122	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/07 16:20
S9	404	(transient adj liquid adj phase)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/07 16:21